Devcon Floor Patch™ FC

Epoxy; Epoxide

Devcon

Message:

A fast-curing, concrete patching compound that bonds to concrete, brick, masonry, metal, or wood and returns repair area to service in three hours. Intended Use:

Fast curing repairs to concrete floors where you need to have medium to heavy traffic on the floor in 3 hours. Used to repair expansion joints which have been damaged by forklift traffic. Used to anchor metal rails in concrete.

Product Features:

Bonds to damp surfaces

Easily troweled to 1/4" or more

Applies on cold or damp surfaces (with primer)

General Information			
Features	Adhesiveness		
	Fast curing		
Uses	Floor maintenance/repair		
	Repair Materials		
Appearance	Grey		
Physical	Nominal Value	Unit	Test Method
Solid content-by Volume	100	%	
Temperature Resistance	121	°C	
Hardness	Nominal Value	Unit	Test Method
Durometer Hardness (Shore D)	85		ASTM D2240
Mechanical	Nominal Value	Unit	Test Method
Compressive Strength	55.2	MPa	ASTM D695
Thermoset	Nominal Value	Unit	
Thermoset Components			
Component a	Mixing ratio by weight: 2.0		
Component B	Mixing ratio by weight: 1.0		
Pot Life (24°C)	15	min	
Additional Information	Nominal Value	Unit	
Cured 7 days @ 75°F			
Uncured Properties	Nominal Value	Unit	
Curing Time (24°C)	3.0	hr	

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Susheng Import & Export Trading Co.,Ltd.

Tel: +86 21 5895 8519

Phone: +86 13424755533

Email: sales@su-jiao.com

No. 215, Lianhe North Road, Fengxian District, Shanghai, China

